ASSOCIATION CONNECT	© Copyright 2005, IPC, 1	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						als and Mf	g Infor	rmation		
upplier Infor	rmation															
Company name*			Company unique ID			Unique ID Authority					Response Date*					
nsemi												2025-06-06				
Contact Name		Tit	Title - Contact			I	Phone - Contact*					Email - Contact*				
Product-Env-Ste	wards	Pro	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - I				Citle - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Ste	wards	Pro	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reque	ester Item Number	Mfr Item Nun	tem Number Mfr Item Name				Effective Da	ffective Date Version		Manufacturing Site		W	Weight* UOM		JOM	Unit Type
		CAV25512HU5E-GT3 512		512KB SPI SER CMOS EEPROM)M	2025-06-06 M		MY1		1	11.98 mg		ng	Each	
Ianufacturin	g Proccess Information	1														
Termin	al Plating / Grid Array Materia	al Termi	Terminal Base Alloy J		J-STD-020 MS	20 MSL Rating		Peak Process Body Temperatur		re Max Time at Peak Temper		Temperatu	re N	lumber of F	Reflow Cyc	les
Preciou Sn)			CU Alloy 1		1		260		C		30 seco		s 3			
Comments																
vel 1 - maximun	n time at peak temperature d	luring solderi	ing is 10-30	seconds												
or more informa	ation regarding material com	position pleas	se refer to p	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not orditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.193	mg	Supplier	Silicon (Si)	7440-21-3		1.193	mg
Die Attach	0.159	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.0556	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.1033	mg
Lead Frame	6.696	mg	Supplier	Tin (Sn)	7440-31-5		0.0167	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0147	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0167	mg
			Supplier	Copper (Cu)	7440-50-8		6.6478	mg
Mold Compound-Black	3.813	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.305	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0191	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0763	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.2982	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.1144	mg
Plating	0.075	mg	Supplier	Palladium (Pd)	7440-05-3		0.0057	mg
			В	Nickel (Ni)	7440-02-0		0.0683	mg
			Supplier	Gold (Au)	7440-57-5		0.001	mg
Wire Bond - Au	0.044	mg	Supplier	Gold (Au)	7440-57-5		0.044	mg